September 2001

FDC638P

P-Channel 2.5V PowerTrench[®] Specified MOSFET

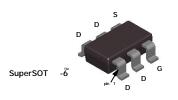
General Description

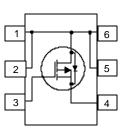
This PChannel 2.5V specified MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance

These devices are well suited for battery power applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -4.5 A, -20 V. $R_{DS(ON)}$ = 48 m Ω @ V_{GS} = -4.5 V R_{DS(ON)} = 65 m Ω @ V_{GS} = -2.5 V
- Low gate charge (10 nC typical)
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- SuperSOT [™] –6 package: small footprint (72% smaller than standard SO-8; low profile (1mm thick)





Absolute Maximum Ratings T_{A=25°C unless otherwise noted}

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
Ь	Drain Current – Continuous	(Note 1a)	-4.5	А
	– Pulsed		-20	
PD	Power Dissipation for Single Operation	(Note 1a)	1.6	W
		(Note 1b)	0.8	V V
T _J , T _{STG}	Operating and Storage Junction Tempera	ture Range	-55 to +150	
Therma	I Characteristics	· · · · ·		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		78	°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W
	e Marking and Ordering Info	ormation eel Size	Tape width	Quantity

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Off Chara BV _{DSS}	acteristics					
BV _{DSS}						
	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		-14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)			1		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_{D} = -250 \ \mu A$	-0.4	-0.8	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$l_{\rm D} = -250 \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$	-	3		mV/ºC
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -4.5 \ V, & I_D = -4.5 \ A \\ V_{GS} = -2.5 \ V, & I_D = -3.8 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -4.5 \ T_J = 125^\circ C \end{array} $		39 52 54	48 65 72	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-20			Α
g fs	Forward Transconductance	$V_{DS} = -10 V$, $I_D = -4.5 A$		15		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		1160		pF
Coss	Output Capacitance	f = 1.0 MHz		195		pF
C _{rss}	Reverse Transfer Capacitance			105		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -5 V$, $I_D = -1 A$,		12	22	ns
t _r	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \qquad R_{GEN} = 6 \ \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time	-		33	53	ns
t _f	Turn–Off Fall Time	-		12	22	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -4.5 A$,		10	14	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -4.5 V$		2.2		nC
Q _{gd}	Gate–Drain Charge			1.5		nC
Drain-Sc	ource Diode Characteristics a	and Maximum Ratings				
ls	Maximum Continuous Drain–Source I	•			-1.3	А
	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -1.3 A$ (Note 2)		-0.73	-1.2	V



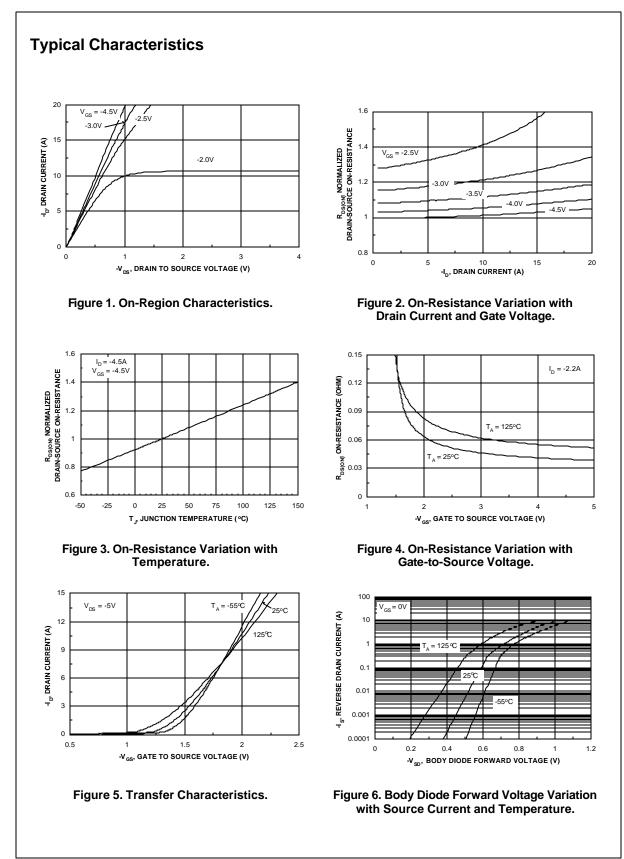
78°C/W when mounted on a 1in² pad of 2 oz copper



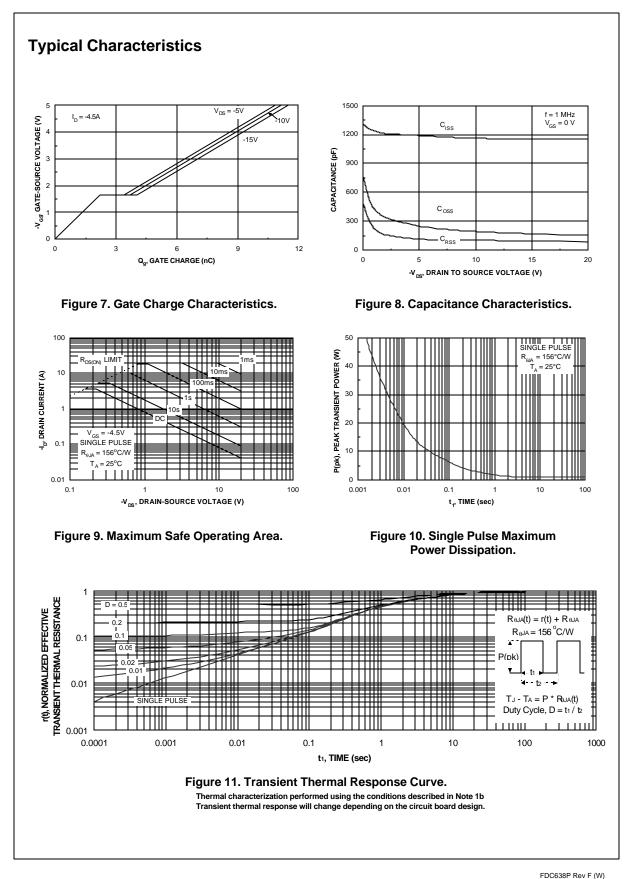
156°C/W when mounted on a minimum pad of 2 oz copper

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty Cycle < 2.0%

FDC638P Rev F (W)



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